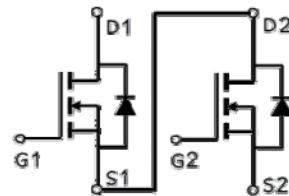


NIKO-SEM**Dual N-Channel Enhancement Mode
Field Effect Transistor****PKC46DY**
PDFN 5x6P
Halogen-Free & Lead-Free**PRODUCT SUMMARY**

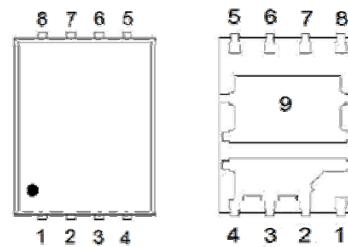
	$V_{(BR)DSS}$	$R_{DS(on)}$	I_D
Q2	30V	1.9mΩ	99A
Q1	30V	9.5mΩ	34A

**Features**

- Pb-Free, Halogen Free and RoHS compliant.
- Low $R_{DS(on)}$ to Minimize Conduction Losses.
- Ohmic Region Good $R_{DS(on)}$ Ratio.
- Optimized Gate Charge to Minimize Switching Losses.

Applications

- Protection Circuits Applications.
- Logic/Load Switch Circuits Applications
- Computer for DC to DC Converters Applications.



1 : G1
2,3,4 : D1
5,6,7 : S2
8 : G2
9 : S1/D2

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS	SYMBOL	Q2	Q1	UNITS
Drain-Source Voltage	V_{DS}	30	30	V
Gate-Source Voltage	V_{GS}	± 20	± 20	V
Continuous Drain Current ³	I_D	99	34	A
		63	21	
Pulsed Drain Current ¹	I_{DM}	150	70	
Continuous Drain Current	I_D	25	9.2	
		20	7.3	
Avalanche Current	I_{AS}	52	22	
Avalanche Energy	E_{AS}	135	24	mJ
Power Dissipation	P_D	36	24	W
		14.7	9.6	
Power Dissipation	P_D	2.4	1.7	W
		1.5	1.1	
Operating Junction & Storage Temperature Range	T_j, T_{stg}	-55 to 150		°C

NIKO-SEM**Dual N-Channel Enhancement Mode
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THERMAL RESISTANCE	SYMBOL		TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient ²	R _{θJA}	Q2		52	°C / W
	R _{θJA}	Q1		72	
Junction-to-Case	R _{θJC}	Q2		3.4	°C / W
	R _{θJC}	Q1		5.2	

¹Pulse width limited by maximum junction temperature T_{J(MAX)}=150°C.²The value of R_{θJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C. The value in any given application depends on the user's specific board design.³Package limitation current :Q1=35A,Q2=35A.**ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)**

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	Q2	30		
			Q1	30		
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	Q2	1.3	1.75	2.3
			Q1	1.3	1.75	2.3
Gate-Body Leakage	I _{GSS}	V _{DS} = 0V, V _{GS} = ±20V	Q2			±100
			Q1			±100
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 24V, V _{GS} = 0V	Q2			1
			Q1			1
		V _{DS} = 20V, V _{GS} = 0V, T _J = 55 °C	Q2			10
			Q1			10
Drain-Source On-State Resistance ¹	R _{DS(ON)}	V _{GS} = 4.5V, I _D = 16A	Q2		2.1	2.5
		V _{GS} = 4.5V, I _D = 13A	Q1		10.5	14
		V _{GS} = 10V, I _D = 20A	Q2		1.5	1.9
		V _{GS} = 10V, I _D = 13A	Q1		6.7	9.5
Forward Transconductance ¹	g _{fs}	V _{DS} = 5V, I _D = 20A	Q2		72	
		V _{DS} = 5V, I _D = 10A	Q1		37	

NIKO-SEM
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DYNAMIC								
Input Capacitance	C_{iss}		$V_{GS} = 0V, V_{DS} = 15V, f = 1MHz$	Q2		2868		
Output Capacitance	C_{oss}			Q1		525		
Reverse Transfer Capacitance	C_{rss}			Q2		515		
Gate Resistance	R_g			Q1		146		
Total Gate Charge ²	Q_g	$V_{GS} = 10V$		Q2		315		
Gate-Source Charge ²		$V_{GS} = 4.5V$		Q1		70		
Gate-Drain Charge ²	Q_{gd}		$V_{DS} = 15V, I_D = 20A$ $V_{DS} = 15V, I_D = 13A$	Q2		1.1		
Turn-On Delay Time ²	$t_{d(on)}$			Q1		1.1		
Rise Time ²	t_r			Q2		56		
Turn-Off Delay Time ²	$t_{d(off)}$			Q1		10.5		
Fall Time ²	t_f			Q2		29		
				Q1		5.8		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J = 25^\circ C$)								
Continuous Current ³	I_S		$I_F = 20A, V_{GS} = 0V$ $I_F = 13A, V_{GS} = 0V$	Q2		25		
Forward Voltage ¹	V_{SD}			Q1		11		
Reverse Recovery Time	t_{rr}		$I_F = 20A, dI_F/dt = 100A/\mu S$ $I_F = 13A, dI_F/dt = 100A/\mu S$	Q2		18		
Reverse Recovery Charge	Q_{rr}			Q1		10		
				Q2		54		
				Q1		7		
				Q2		20		
				Q1		5		

¹Pulse test : Pulse Width $\leq 300 \mu sec$, Duty Cycle $\leq 2\%$.²Independent of operating temperature.³Package limitation current : Q1=35A, Q2=35A.

NIKO-SEM

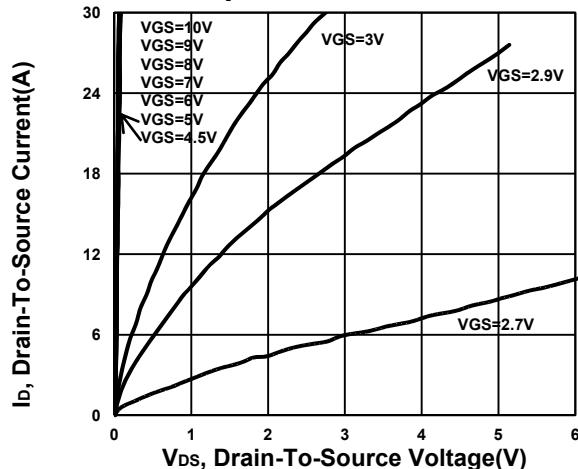
**Dual N-Channel Enhancement Mode
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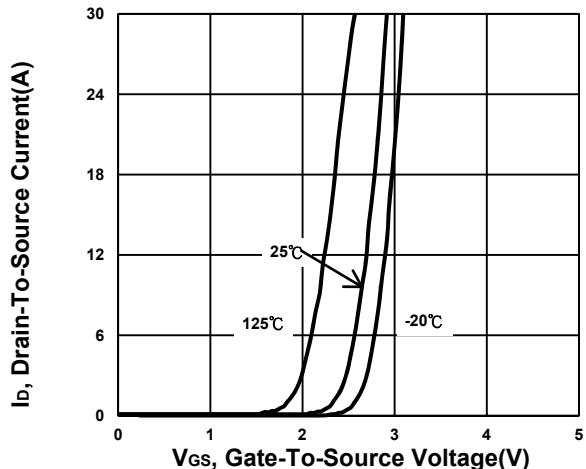
TYPICAL PERFORMANCE CHARACTERISTICS

Q2

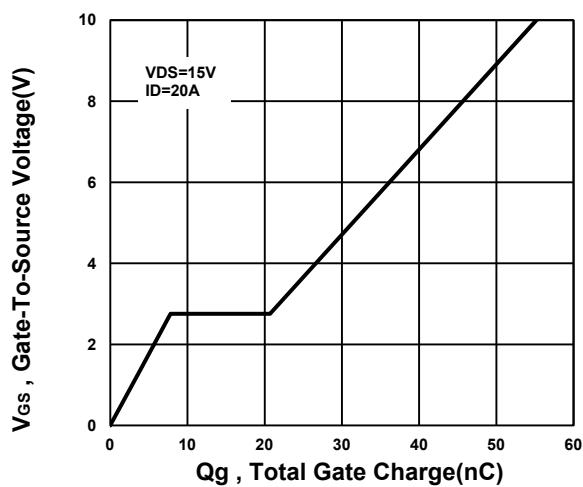
Output Characteristics



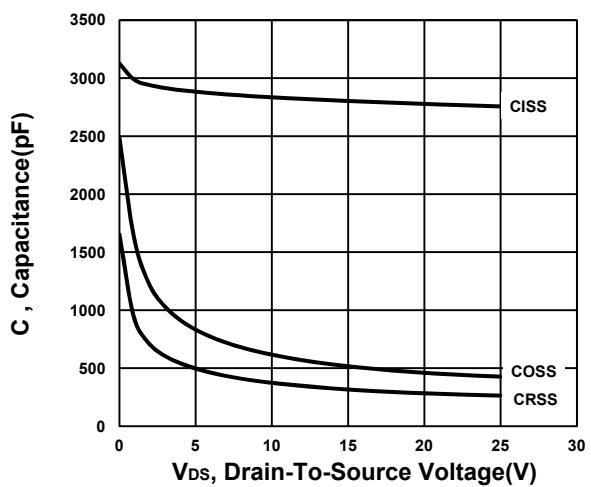
Transfer Characteristics



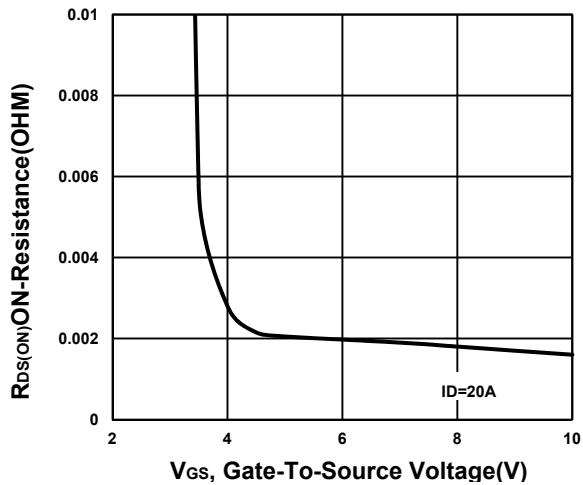
Gate charge Characteristics



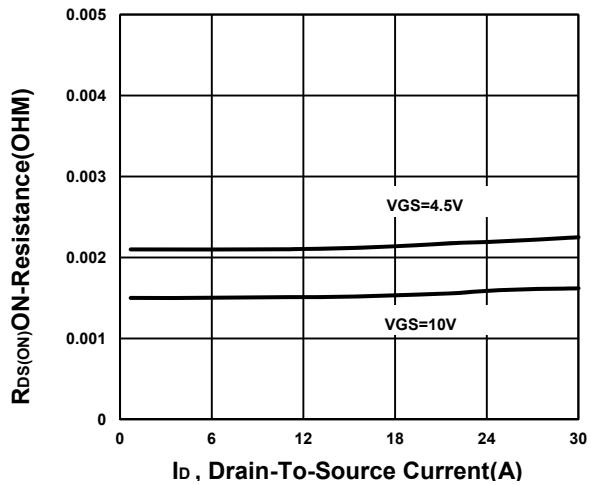
Capacitance Characteristic

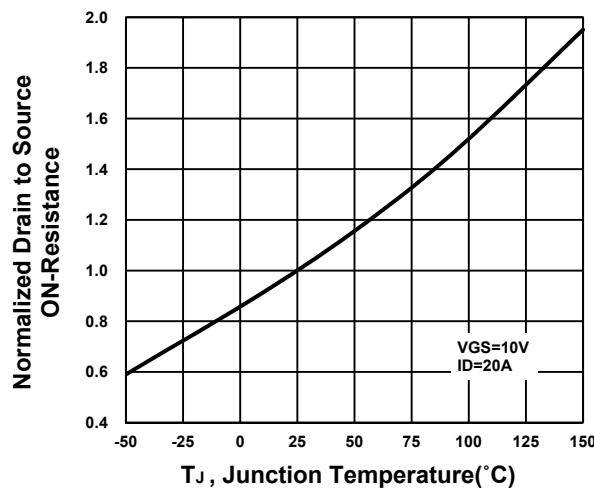
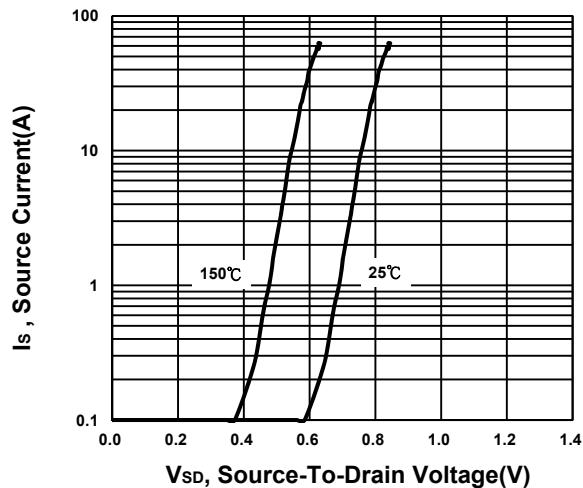
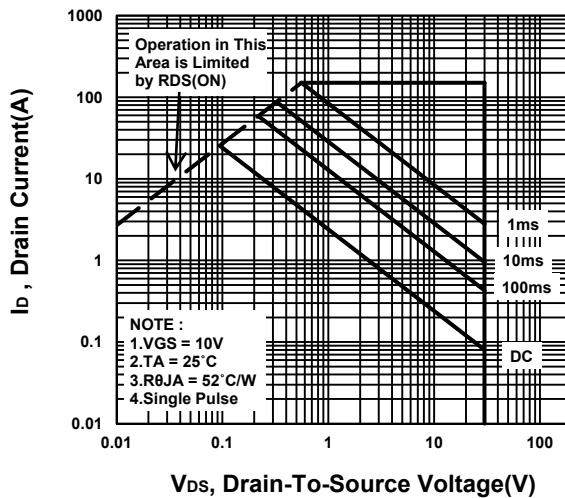
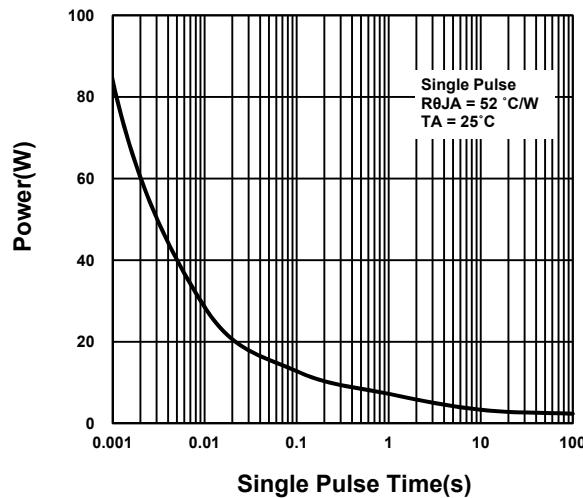
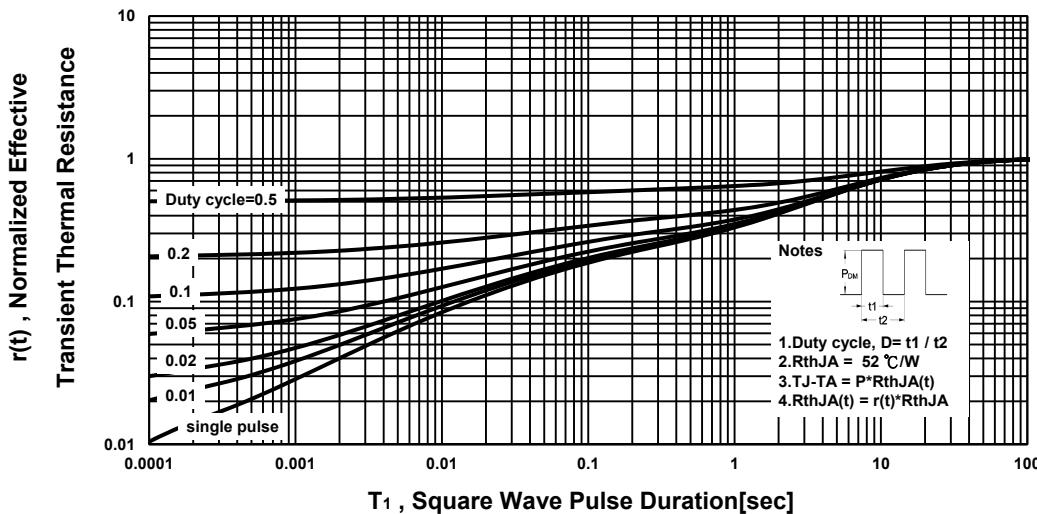


On-Resistance VS Gate-To-Source



On-Resistance VS Drain Current



NIKO-SEM**Dual N-Channel Enhancement Mode
Field Effect Transistor****PKC46DY
PDFN 5x6P
Halogen-Free & Lead-Free****On-Resistance VS Temperature****Source-Drain Diode Forward Voltage****Safe Operating Area****Single Pulse Maximum Power Dissipation****Transient Thermal Response Curve**

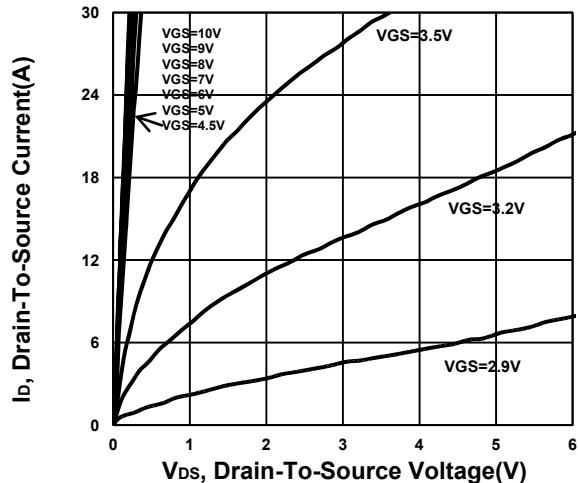
NIKO-SEM

**Dual N-Channel Enhancement Mode
Field Effect Transistor**

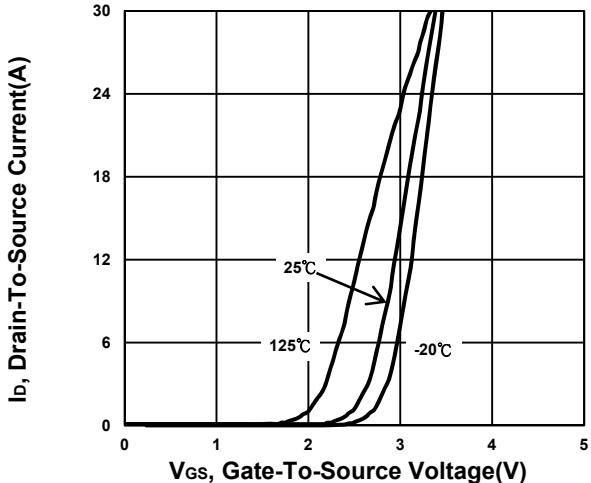
PKC46DY
PDFN 5x6P
Halogen-Free & Lead-Free

Q1

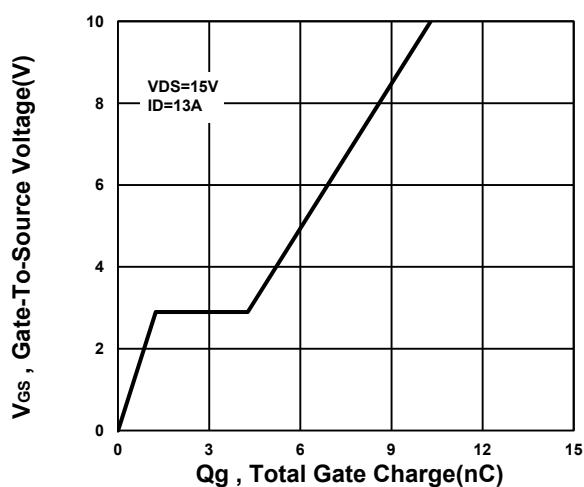
Output Characteristics



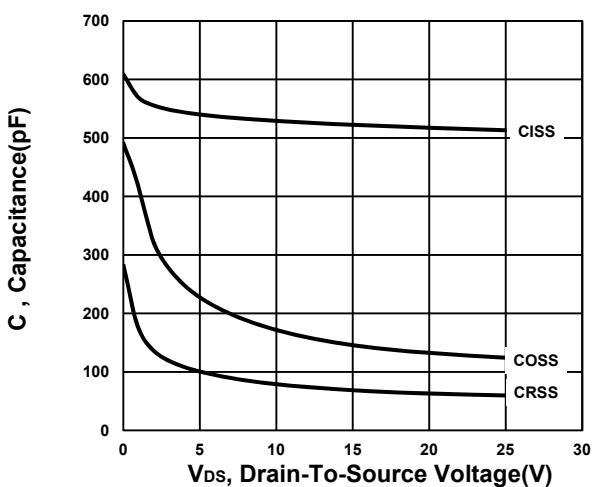
Transfer Characteristics



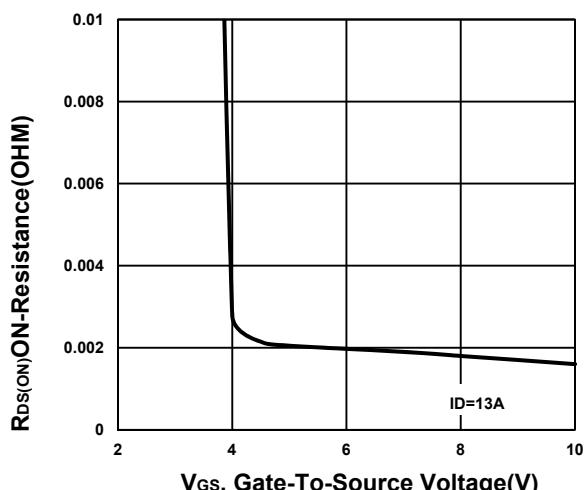
Gate charge Characteristics



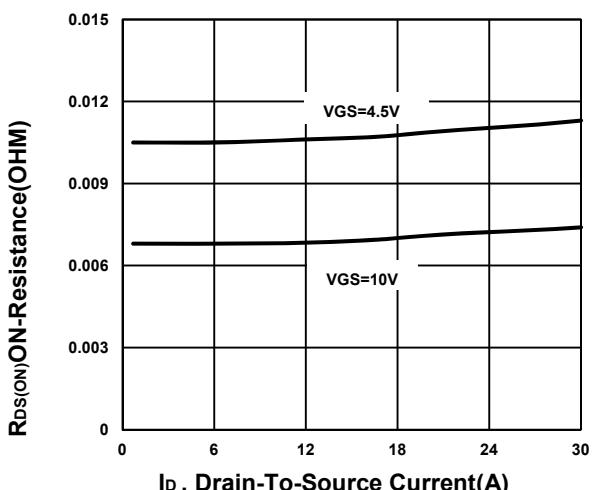
Capacitance Characteristic

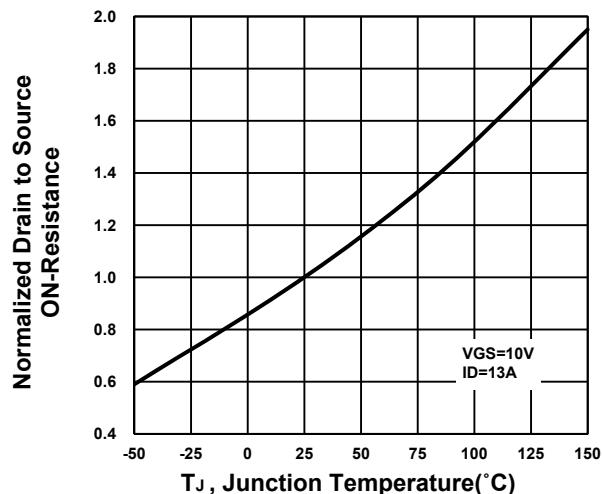
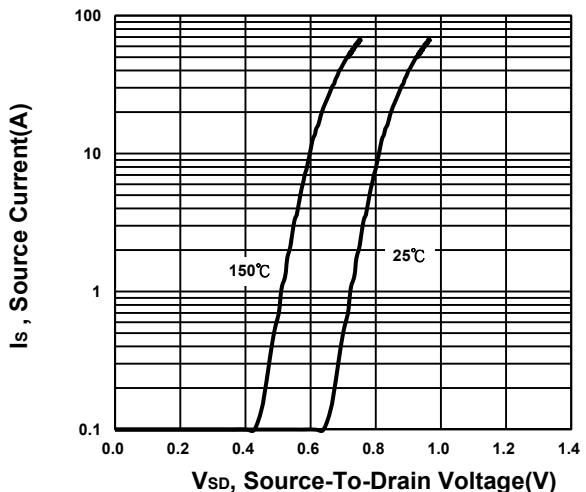
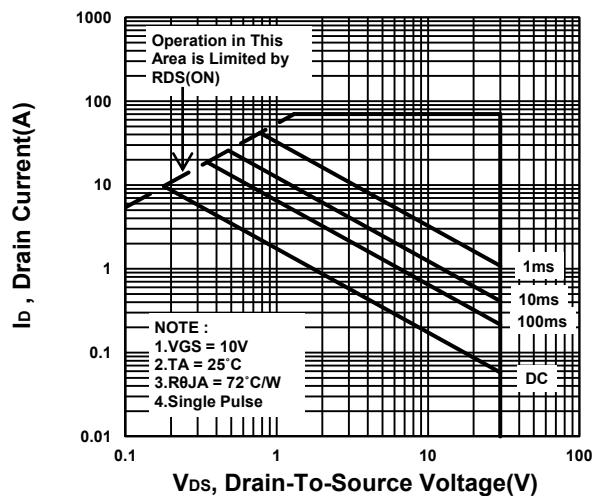
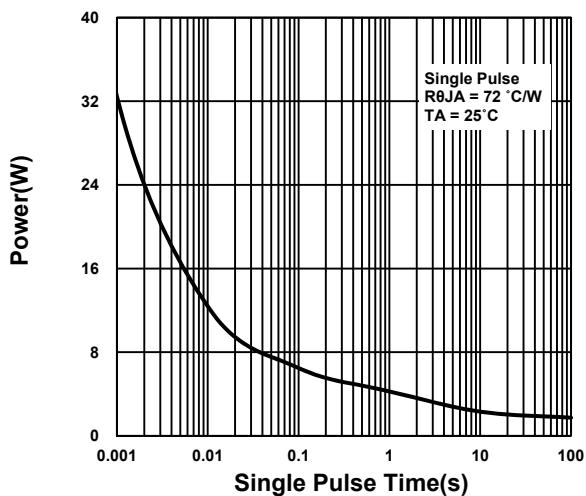


On-Resistance VS Gate-To-Source



On-Resistance VS Drain Current



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